## INTEGRATED CIRCUITS



Product data Supersedes data of 1994 Aug 31 File under Integrated Circuits; IC11 Data Handbook 2001 Aug 03



HILIP

## NE/SA5090

#### DESCRIPTION

The NE/SA5090 addressable relay driver is a high-current latched driver, similar in function to the 9934 address decoder. The device has 8 open-collector Darlington power outputs, each capable of 150 mA load current. The outputs are turned on or off by respectively loading a logic "1" or logic "0" into the device data input. The required output is defined by a 3-bit address. The device must be enabled by a  $\overline{CE}$  input line which also serves the function of further address decoding. A common clear input,  $\overline{CLR}$ , turns all outputs off when a logic "0" is applied. The device is packaged in a 16-pin plastic DIP or SO package.

#### FEATURES

- 8 high-current outputs
- Low-loading bus-compatible inputs
- Power-on clear ensures safe operation
- Will operate in addressable or demultiplex mode
- Allows random (addressed) data entry
- Easily expandable
- Pin-compatible with 9334 (Philips or Fairchild)

#### **PIN CONFIGURATION**

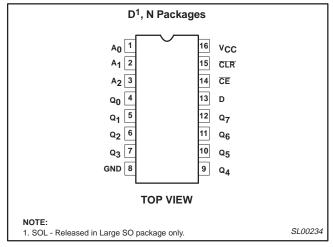


Figure 1. Pin Configuration

#### **APPLICATIONS**

- Relay driver
- Indicator lamp driver
- Triac trigger
- LED display digit driver
- Stepper motor driver

#### **BLOCK DIAGRAM**

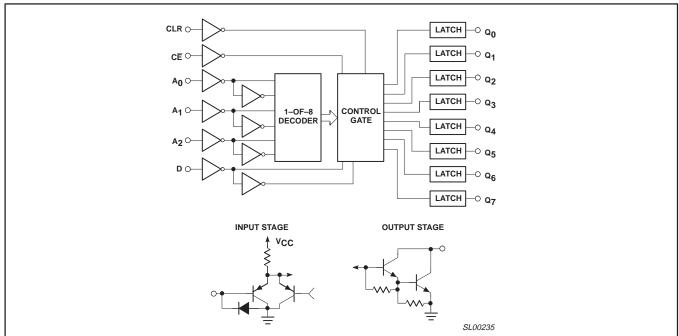


Figure 2. Block Diagram

NE/SA5090

Product data

#### **PIN DESIGNATION**

PIN NO.	SYMBOL	NAME AND FUNCTION
1-3	A <sub>0</sub> -A <sub>2</sub>	A 3-bit binary address on these pins defines which of the 8 output latches is to receive the data.
4-7, 9-12	Q <sub>0</sub> -Q <sub>7</sub>	The 8 device outputs.
13	D	The data input. When the chip is enabled, this data bit is transferred to the defined output such that: "1" turns output switch "ON" "0" turns output switch "OFF"
14	CE	The chip enable. When this input is low, the output latches will accept data. When CE goes high, all outputs will retain their existing state, regardless of address of data input condition.
15	CLR	The clear input. When CLR goes low all output switches are turned "OFF". The high data input will override the clear function on the addressed latch.

#### **ORDERING INFORMATION**

DESCRIPTION	TEMPERATURE RANGE	ORDER CODE	DWG #
16-Pin Plastic Small Outline Large (SOL) Package	0 °C to +70 °C	NE5090D	SOT162-1
16-Pin Plastic Dual In-Line Package (DIP)	0 °C to +70 °C	NE5090N	SOT38-4
16-Pin Plastic Small Outline Large (SOL) Package	–40 °C to +85 °C	SA5090D	SOT162-1
16-Pin Plastic Dual In-Line Package (DIP)	–40 °C to +85 °C	SA5090N	SOT38-4

#### TRUTH TABLE

		INP	UTS			OUTPUTS						MODE		
CLR	CE	D	A <sub>0</sub>	A <sub>1</sub>	A <sub>2</sub>	Q <sub>0</sub>	Q <sub>1</sub>	Q <sub>2</sub>	$Q_3$	$Q_4$	$Q_5$	$Q_6$	Q <sub>7</sub>	MODE
L	Н	Х	Х	Х	Х	Н	Н	Н	Н	Н	Н	Н	Н	Clear
L	L	L	L	L	L	н	Н	Н	Н	Н	Н	Н	Н	
L	L	Н	L	L	L	L	Н	Н	Н	Н	Н	Н	Н	
L	L	L	Н	L	L	н	Н	Н	Н	Н	Н	Н	Н	Demultiplex
L	L	Н	Н	L	L	н	L	Н	Н	Н	Н	Н	Н	Demuliplex
L	L	L	Н	Н	Н	н	Н	Н	Н	Н	Н	Н	Н	
L	L	Н	Н	Н	Н	н	Н	Н	Н	Н	Н	Н	L	
Н	Н	Х	Х	Х	Х	Q <sub>N-1</sub>								Memory
Н	L	L	L	L	L	н	Q <sub>N-1</sub>						•	
Н	L	Н	L	L	L	L	$Q_{N-1}$							
Н	L	L	Н	L	L	Q <sub>N-1</sub>	Н	Q <sub>N-1</sub>						Addressable Latch
Н	L	Н	Н	L	L	Q <sub>N-1</sub>	L	$Q_{N-1}$						AUUICOODUC LAILII
Н	L	L	Н	Н	Н	Q <sub>N-1</sub>							Н	
Н	L	Н	Н	Н	Н	Q <sub>N-1</sub>							L	

NOTES:

X=Don't care condition

Q<sub>N-1</sub>=Previous output state

L=Low voltage level/"ON" output state

H=High voltage level/"OFF" output state

#### **ABSOLUTE MAXIMUM RATINGS**

 $T_{amb}$  = 25 °C, unless otherwise specified.

SYMBOL	PARAMETER	RATING	UNIT
V <sub>CC</sub>	Supply voltage	-0.5 to +7	V
V <sub>IN</sub>	Input voltage	-0.5 to +15	V
V <sub>OUT</sub>	Output voltage	0 to +30	V
I <sub>GND</sub>	Ground current	500	mA
I <sub>OUT</sub>	Output current Each output	200	mA
P <sub>D</sub>	Maximum power dissipation, T <sub>amb</sub> = 25 °C (still-air) <sup>1</sup> N package D package	1712 1315	mW mW
T <sub>amb</sub>	Ambient temperature range	0 to +70	°C
Тj	Junction temperature	150	°C
T <sub>stg</sub>	Storage temperature range	-65 to +150	°C
T <sub>sld</sub>	Lead soldering temperature (10 sec. max)	230	°C

NOTE:

1. Derate above 25 °C at the following rates: N package at 13.7 mW/°C D package at 10.5 mW/°C

#### DC ELECTRICAL CHARACTERISTICS

 $V_{CC}$  = 4.75 V to 5.25 V; 0  $^\circ C \leq T_{amb} \leq$  +70  $^\circ C,$  unless otherwise specified.

SYMPOL	DADAMETED	TEST CONDITIONS		LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	Min	Min Typ		UNIT	
	Input voltage						
V <sub>IH</sub>	High		2.0			V	
V <sub>IL</sub>	Low				0.8		
	Output voltage						
V <sub>OL</sub>	Low	$I_{OL}$ = 150 mA, $T_{amb}$ = 25 °C		1.05	1.30	V	
		Over temperature			1.50		
	Input current						
I <sub>IH</sub>	High	$V_{IN} = V_{CC}$		<1.0	10	μA	
IIL	Low	$V_{IN} = 0 V$		-3.0	-250		
I <sub>OH</sub>	Leakage current	V <sub>OUT</sub> = 28 V		5	250	μA	
	Supply current						
I <sub>CCL</sub>	All outputs low	$V_{CC} = 5.25 V$		35	60	mA	
I <sub>CCH</sub>	All outputs high			22	50		
PD	Power dissipation	No output load			315	mW	

**NOTE:** 1. All typical values are at  $V_{CC} = 5$  V and  $T_{amb} = 25$  °C.

Product data

### Product data

### NE/SA5090

#### SWITCHING CHARACTERISTICS

 $V_{CC} = 5 \text{ V}; \text{ T}_{amb} = 25 \text{ °C}; \text{ V}_{OUT} = 5 \text{ V}; \text{ I}_{OUT} = 100 \text{ mA}; \text{ V}_{IL} = 0.8 \text{ V}; \text{ V}_{IH} = 2.0 \text{ V}.$ 

SYMBOL	PARAMETER	TO FROM		MIN	TYP	MAX	UNIT
Propagation	n delay time		•			•	
t <sub>PLH</sub>	Low-to-high <sup>1</sup>	Output	CE		900	1800	ns
t <sub>PHL</sub>	High-to-low <sup>1</sup>				130	260	
t <sub>PLH</sub>	Low-to-high <sup>2</sup>	Quitaut	Data		920	1850	
t <sub>PHL</sub>	High-to-low <sup>2</sup>	Output	Data		130	30 260	ns
t <sub>PLH</sub>	Low-to-high <sup>3</sup>	Quitaut	Address		900	1800	
t <sub>PHL</sub>	High-to-low <sup>3</sup>	Output	Address		130	260	ns
t <sub>PLH</sub>	Low-to-high <sup>4</sup>	Quitaut			920	1850	
t <sub>PHL</sub>	High-to-low <sup>4</sup>	Output	CLR				ns
Switching	setup requirements						
	Set-up time HIGH	Chip enable	High data	40			
t <sub>S(H)</sub>	Set-up time LOW	Chip enable	Low data	50			ns
t <sub>S(A)</sub>	Address set-up time	Chip enable	Address	40			ns
	Hold time HIGH	Chip enable	High data	10			
t <sub>H(H)</sub>	Hold time LOW	Chip enable	Low data	10			ns
t <sub>PW(E)</sub>	Chip enable pulse width <sup>1</sup>			40			ns

NOTES:

1. See Turn-On and Turn-Off Delays, Enable-to-Output and Enable Pulse Width timing diagram.

2. See Turn-On and Turn-Off Delays, Data-to-Output timing diagram.

3. See Turn-On and Turn-Off Delays, Address-to-Output timing diagram.

See Turn-Off Delay, Clear-to-Output timing diagram.

5. See Set-up and Hold Time, Data-to-Enable timing diagram.

6. See Set-up Time, Address-to-Enable timing diagram.

#### FUNCTIONAL DESCRIPTION

This peripheral driver has latched outputs which hold the input date until cleared. The NE5090 has active-LOW, open-collector outputs, all of which are cleared when power is first applied. This device is identical to the NE590, except the outputs can withstand 28 V.

#### Addressable Latch Function

Any given output can be turned on or off by presenting the address of the output to be set or cleared to the three address pins, by holding the "D" input High to turn on the selected output, or by holding it Low to turn off, holding the  $\overline{CLR}$  input High, and bringing the  $\overline{CE}$  input Low. Once an output is turned on or off, it will remain so until addressed again, or until all outputs are cleared by bringing the  $\overline{CLR}$  input Low while holding the  $\overline{CE}$  input High.

#### **Demultiplexer Operation**

By holding the  $\overline{CLR}$  and  $\overline{CE}$  inputs Low and the "D" input High, the addressed output will remain on and all other outputs will be off.

#### **High Current Outputs**

The obvious advantage of this device over other drivers such as the 9334 and N74LS259 is the fact that the outputs of the NE5090 are each capable of 200 mA and 28 V. It must be noted, however, that the total power dissipation would be over 2.5 W if all 8 outputs were on together and carrying 200 mA each. Since the total power dissipation is limited by the package to 1 W, and since power dissipation due to supply current is 0.25 W, the total load power

dissipation by the device is limited to 0.75 W at room temperature, and decreases as ambient temperature rises.

The maximum die junction temperature must be limited to 165 °C, and the temperature rise above ambient and the junction temperature are defined as:

$$T_{R} = \theta_{JA} \times P_{D}$$
$$T_{i} = T_{amb} + t_{R}$$

For example, if we are using the NE5090 in a plastic package in an application where the ambient temperature is never expected to rise above 50 °C, and the output current at the 8 outputs, when on, are 100, 40, 50, 200, 15, 30, 80, and 10 mA, we find from the graph of output voltage vs load current that the output voltages are expected to be about 0.92, 0.75, 0.78, 1.04, 0.5, 0.7, 0.9, and 0.4 V, respectively. Total device power due to these loads is found to be 473.5 mW. Adding the 200 mW due to the power supply brings total device power dissipation to 723.5 mW. The thermal resistances are 83 °C per W for plastic packages. Using the equations above we find:

Plastic T<sub>R</sub>=83×0.7235=60°C Plastic T<sub>J</sub> =50+60=100°C

Thus we find that  $T_J$  is below the 165 °C maximum, and either package could be used in this application. The graphs of total load power versus ambient temperature would also give us this same information, although interpreting the graphs would not yield the same accuracy.

## NE/SA5090

#### **TIMING DIAGRAMS**

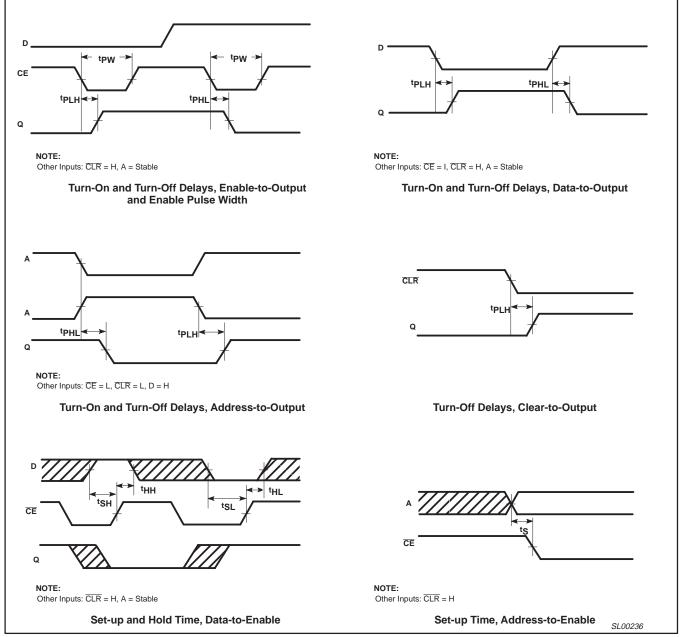


Figure 3. Timing Diagrams

### NE/SA5090

#### **TYPICAL APPLICATIONS**

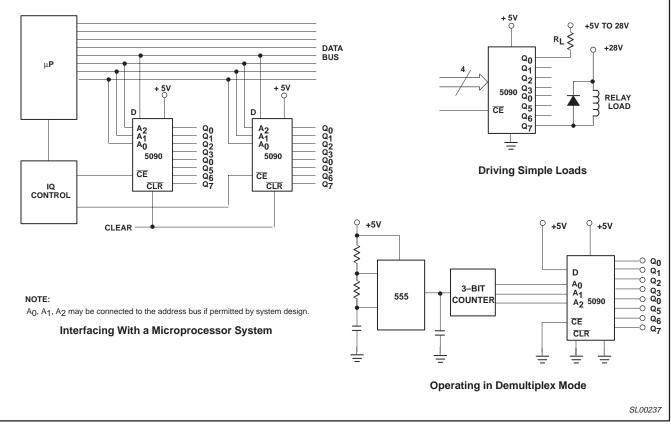
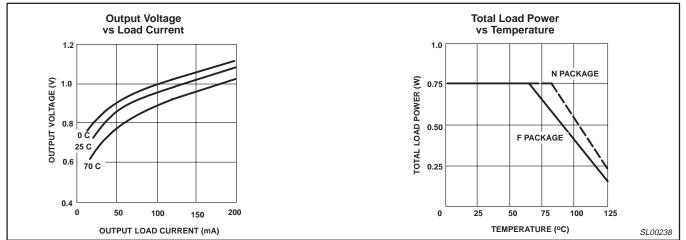


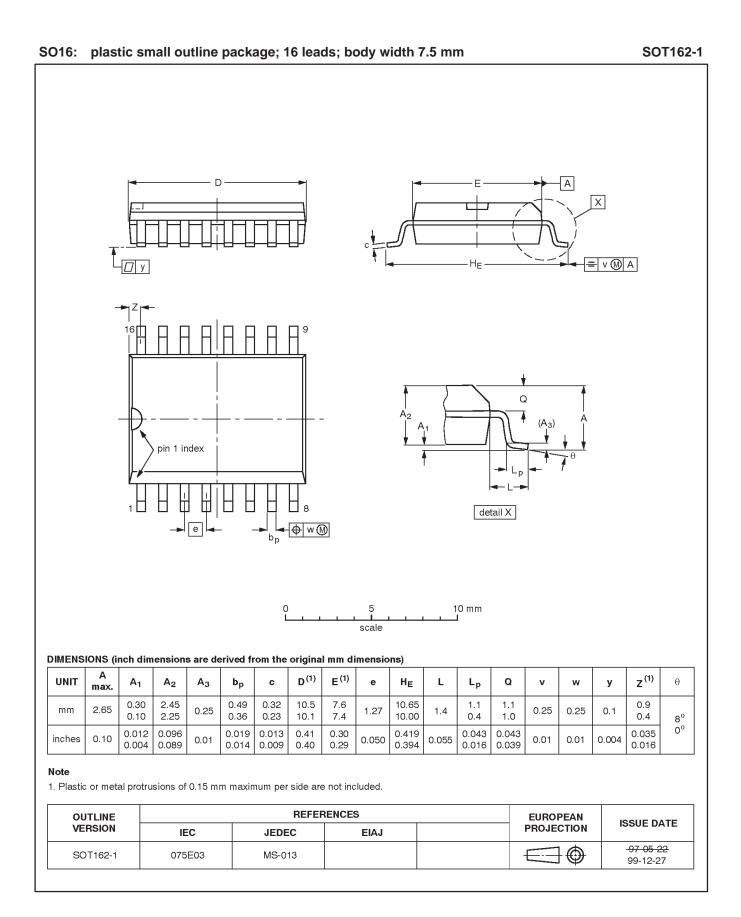
Figure 4. Typical Applications

#### **TYPICAL PERFORMANCE CHARACTERISTICS**



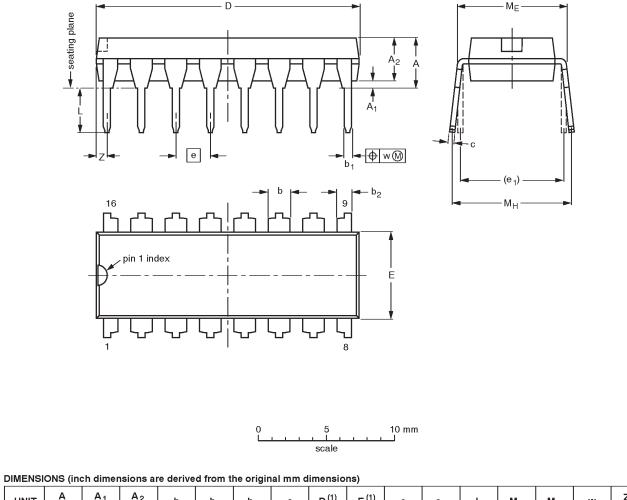


NE/SA5090



Product data

### DIP16: plastic dual in-line package; 16 leads (300 mil)



UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	b <sub>2</sub>	с	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	L	ME	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		EUROPEAN				
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT38-4						<del>-92-11-17</del> 95-01-14



Product data

Product data

#### Data sheet status

Data sheet status <sup>[1]</sup>	Product status <sup>[2]</sup>	Definitions
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A.

[1] Please consult the most recently issued data sheet before initiating or completing a design.

[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

#### Definitions

**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

#### Disclaimers

Life support — These products are not designed for use in life support appliances, devices or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

**Right to make changes** — Philips Semiconductors reserves the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

#### Contact information

For additional information please visit http://www.semiconductors.philips.com. Fax: +31

Fax: +31 40 27 24825

© Koninklijke Philips Electronics N.V. 2001 All rights reserved. Printed in U.S.A.

Date of release: 12-01

For sales offices addresses send e-mail to: sales.addresses@www.semiconductors.philips.com

Document order number:

9397 750 09176

Let's make things better.



